DATA SHEET

MAX6326/MAX6327/MAX6328/ MAX6346/MAX6347/MAX6348 3-pin ultra-low power SC70/SOT microprocessor reset circuit

Product data
Supersedes data of 2003 Apr 30

2003 Aug 05







3-pin ultra-low power SC70/SOT microprocessor reset circuit

MAX632x/MAX634x

DESCRIPTION

The MAX6326/MAX6327//MAX6328/MAX6346/MAX6347/MAX6348 microprocessor (μP) reset circuits monitor power supplies in μP and digital systems. These devices eliminate external components and adjustments while providing excellent circuit reliability and low cost solution. They are used to monitor 2.5 V, 3 V, 3.3 V and 5 V power supplies.

They assert a reset signal when the V_{DD} supply voltage falls below a preset reset threshold voltage. The reset signal remains asserted for at least 100 ms after the V_{DD} rises above the reset threshold. The reset threshold are factory trimmable from 2.2 V to 4.63 V in approximately 100 mV increments. All these parts are guaranteed to assert a reset for V_{DD} down to 1 V. They have excellent immunity to fast transients on V_{DD} .

The devices vary in their output configuration. The MAX6326/MAX6346 have push-pull, active-LOW reset output; while the MAX6328/MAX6348 have open drain, active-LOW reset output. The MAX6327/MAX6347 have push-pull, active HIGH reset output.

The lower threshold MAX6326/MAX6327/MAX6328 have ultra-low supply current of typically 0.5 μ A making them ideal for battery powered applications. All six devices are available in both the 3-pin SOT23 and SC70 packages.

FEATURES

- Ultra-low 1 μA (max) supply current
- Precision monitoring of 2.5 V, 3 V, 3.3 V, and 5 V power supply voltages
- Reset thresholds available from 2.2 V to 4.63 V
- Fully specified over temperature -40 °C to +85 °C
- 100 ms (min) power-on-reset delay time
- Power transient immunity
- Available in three versions: Push-Pull RESET, Push-Pull RESET, and Open-Drain RESET
- Pin compatible with MAX803/MAX809/MAX810
- Small, low cost, 3-pin SC70/SOT23 packages

APPLICATIONS

- Computers and controllers
- Power monitoring
- Portable/battery powered equipment
- Industrial equipment

SIMPLIFIED SYSTEM DIAGRAM

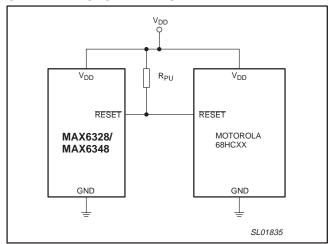


Figure 1. MAX6328/6348 simplified system diagram.

MAX632x/MAX634x

ORDERING INFORMATION

MAX632x

| TYPE | PACKAGE | | TEMPERATURE | RESET | | |
|-------------|---------|--|------------------|------------|--------------------------|--|
| NUMBER | NAME | DESCRIPTION | RANGE | | | |
| MAX6326-XXD | SOT23-3 | Plastic small outline package; 3 leads; body width 1.5 mm | -40 °C to +85 °C | push-pull | Active-LOW reset output | |
| MAX6326-XXW | SC70-3 | Plastic small outline package; 3 leads; body width 1.15 mm | -40 °C to +85 °C | push-pull | Active-LOW reset output | |
| MAX6327-XXD | SOT23-3 | Plastic small outline package; 3 leads; body width 1.5 mm | -40 °C to +85 °C | push-pull | Active-HIGH reset output | |
| MAX6327-XXW | SC70-3 | Plastic small outline package; 3 leads; body width 1.15 mm | -40 °C to +85 °C | push-pull | Active-HIGH reset output | |
| MAX6328-XXD | SOT23-3 | Plastic small outline package; 3 leads; body width 1.5 mm | -40 °C to +85 °C | open-drain | Active-LOW reset output | |
| MAX6328-XXW | SC70-3 | Plastic small outline package; 3 leads; body width 1.15 mm | -40 °C to +85 °C | open-drain | Active-LOW reset output | |

NOTE:

The device has five standard voltage output options, indicated by the XX on the "Type Number". Additional voltage output options may be available (see Table 1).

| XX (type number suffix) | Voltage (Typical) | | | | |
|-------------------------|-------------------|--|--|--|--|
| 22 | 2.2 V | | | | |
| 23 | 2.3 V | | | | |
| 26 | 2.6 V | | | | |
| 29 | 2.9 V | | | | |
| 31 | 3.1 V | | | | |

MAX634x

| TYPE | PACKAGE | | TEMPERATURE | RESET | | |
|-------------|---------|--|------------------|------------|--------------------------|--|
| NUMBER | NAME | DESCRIPTION | RANGE | | | |
| MAX6346-XXD | SOT23-3 | Plastic small outline package; 3 leads; body width 1.5 mm | –40 °C to +85 °C | push-pull | Active-LOW reset output | |
| MAX6346-XXW | SC70-3 | Plastic small outline package; 3 leads; body width 1.15 mm | -40 °C to +85 °C | push-pull | Active-LOW reset output | |
| MAX6347-XXD | SOT23-3 | Plastic small outline package; 3 leads; body width 1.5 mm | -40 °C to +85 °C | push-pull | Active-HIGH reset output | |
| MAX6347-XXW | SC70-3 | Plastic small outline package; 3 leads; body width 1.15 mm | -40 °C to +85 °C | push-pull | Active-HIGH reset output | |
| MAX6348-XXD | SOT23-3 | Plastic small outline package; 3 leads; body width 1.5 mm | -40 °C to +85 °C | open-drain | Active-LOW reset output | |
| MAX6348-XXW | SC70-3 | Plastic small outline package; 3 leads; body width 1.15 mm | -40 °C to +85 °C | open-drain | Active-LOW reset output | |

NOTE:

The device has two standard voltage output options, indicated by the XX on the "Type Number". Additional voltage output options may be available (see Table 1).

| XX (type number suffix) | Voltage (Typical) | | | | |
|-------------------------|-------------------|--|--|--|--|
| 44 | 4.4 V | | | | |
| 46 | 4.6 V | | | | |



3-pin ultra-low power SC70/SOT microprocessor reset circuit

MAX632x/MAX634x

PINNING

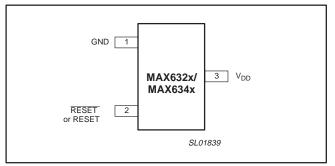


Figure 2. Pin configuration.

MAX6326/MAX6346, MAX6328/MAX6348 pin description

| PIN | SYMBOL | DESCRIPTION |
|-----|----------|---|
| 1 | GND | Device ground |
| 2 | RESET | Active-LOW Reset Output. RESET remains LOW while V _{DD} is below the reset threshold and for a reset delay time of at least 100 ms after V _{DD} rises above the reset threshold. MAX6328/MAX6348 have open-drain output and the MAX6326/MAX6346 are Push-Pull output. |
| 3 | V_{DD} | Positive supply voltage |

MAX6327/MAX6347 pin description

| PIN | SYMBOL | DESCRIPTION |
|-----|----------|---|
| 1 | GND | Device ground |
| 2 | RESET | Active-HIGH Reset Output. RESET remains high while V_{DD} is below the reset threshold and remains HIGH for at least 100 ms after V_{DD} rises above the reset threshold. |
| 3 | V_{DD} | Positive supply voltage |

MAXIMUM RATINGS

| SYMBOL | PARAMETER | CONDITIONS | MIN. | MAX. | UNIT |
|-----------------------|---|--|------|------|------|
| V_{DD} | Supply voltage | | -0.3 | 6.0 | V |
| V _{i(RESET)} | Input voltage at RESET pin (MAX6326/MAX6346, MAX6328/MAX6348) | | -0.3 | 6.0 | V |
| I _{i(VDD)} | Input current at V _{DD} pin | | - | 20 | mA |
| Io | Output current (RESET pin) | | _ | 20 | mA |
| Р | Power dissipation | 3-pin SOT23 (derate 4 mW/°C above T _{amb} = 70 °C) | _ | 320 | mW |
| | | 3-pin SC70 (derate 2.7 mW/°C above T _{amb} = 70 °C) | - | 174 | |
| T _{opr} | Operating temperature | | -40 | +85 | °C |
| T _{stg} | Storage temperature | | -65 | +150 | °C |



3-pin ultra-low power SC70/SOT microprocessor reset circuit

MAX632x/MAX634x

ELECTRICAL CHARACTERISTICS

 V_{DD} = full range (T_{amb} = -40 °C to +85 °C) unless otherwise noted; typical values are at T_{amb} = +25 °C, and V_{DD} = 3 V (Note 1).

| SYMBOL | PARAMETER | CONDITIONS | MIN | TYP | MAX | UNIT |
|------------------------|--|--|---------------------------------------|-----------------|------------------------|--------|
| | V _{DD} range | $T_{amb} = 0 ^{\circ}C \text{ to } +70 ^{\circ}C$ | 1.0 | | 5.5 | V |
| | | $T_{amb} = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$ | 1.2 | | 5.5 | V |
| I _{DD} | Supply current $ \begin{array}{l} \text{MAX632x only, V}_{DD} = 3.0 \text{ V for V}_{th} \leq 2.93 \text{ V,} \\ \text{V}_{DD} = 3.2 \text{ V for V}_{th} > 2.93 \text{ V, no load} \\ \end{array} $ | | _ | 0.5 | 1.0 | μΑ |
| | | $\begin{array}{c ccccccccccccccccccccccccccccccccccc$ | μΑ | | | |
| V_{th} | Reset threshold | $\begin{array}{c ccccccccccccccccccccccccccccccccccc$ | V _{th} + 1.5% | V | | |
| | (Table 1) | $T_{amb} = -40 ^{\circ}\text{C} \text{ to } +85 ^{\circ}\text{C}$ | V _{th} - 2.5% | V _{th} | V _{th} + 2.5% | V |
| ΔV _{th} /°C | Reset threshold temperature coefficient | | _ | 40 | _ | ppm/°C |
| t _{RD} | V _{CC} to Reset release delay | $V_{DD} = V_{th}$ to $(V_{th} - 100 \text{ mV})$ | _ | 20 | _ | μs |
| t _{RP} | Reset active timeout period | | 100 | 185 | 280 | ms |
| (r | RESET output voltage | I _{SINK} = 1.6 mA, V _{DD} > 2.1 V | _ | | 0.3 | V |
| | (reset asserted) | I _{SINK} = 100 mA, V _{DD} ≥ 1.2 V | _ | | 0.4 | V |
| V _{OH(RESET)} | RESET output voltage | I _{SOURCE} = 500 mA, V _{DD} = 3.2 V, MAX6326 only | 0.8 × V _{CC} | | _ | V |
| | (reset released) | I_{SOURCE} = 800 μ A, V_{DD} = 4.5 V, $V_{th} \leq 4.38$ V | 0.8 × V _{CC} | | _ | V |
| | | $I_{SOURCE} = 800 \mu A$, $V_{DD} = V_{th(MAX)}$, $V_{th} \ge 4.5 \text{ V}$ | 0.8 × V _{CC} | | _ | V |
| V _{OH(RESET)} | RESET output voltage (reset asserted) | I _{SOURCE} = 500 μA, V _{DD} ≥ 2.1 V | 0.8 × V _{CC} | | _ | V |
| | (MAX6327/MAX6347) | I _{SOURCE} = 50 μA, V _{DD} ≥ 1.2 V | 0.8 × V _{CC} | | - | V |
| V _{OL(RESET)} | RESET output voltage (reset released) | $I_{SINK} = 1.2 \text{ mA}, V_{DD} \ge 3.2 \text{ V (MAX6327 only)}$ | _ | | 0.3 | V |
| | , | $I_{SINK} = 3.2 \text{ mA}, V_{DD} \ge 3.2 \text{ V}, V_{th} \le 4.38 \text{ V}$ | _ | | 0.4 | V |
| | (MAX6327/MAX6347) | $I_{SINK} = 3.2 \text{ mA}, V_{DD} = V_{th(MAX)}, V_{th} \ge 4.5 \text{ V}$ | , , , , , , , , , , , , , , , , , , , | V | | |
| V _{hys} | RESET threshold hysteresis | MAX6326/MAX6327/MAX6328 | _ | 6.3 | _ | mV |
| | | MAX6346/MAX6347/MAX6348 | _ | 9.5 | _ | mV |
| | Open-drain RESET output leakage current | | _ | | 0.1 | μΑ |

NOTE:

1. Over-temperature limits are guaranteed by design and are not production tested.



3-pin ultra-low power SC70/SOT microprocessor reset circuit

MAX632x/MAX634x

Table 1. Factory-trimmed Reset Thresholds (Note 1)

| PART | SUFFIX (XX) | RESET THRESHOLD VOLTAGE, V _{th} (V) | | | | | | | | |
|------------|-------------|--|-------|-------|--------------------------|-------------|--|--|--|--|
| | | T _{amb} = +25 ° | С | | T _{amb} = -40 ° | C to +85 °C | | | | |
| | | MIN | TYP | MAX | MIN | MAX | | | | |
| MAX632x-XX | 22 | 2.167 | 2.200 | 2.233 | 2.145 | 2.250 | | | | |
| MAX632x-XX | 23 | 2.285 | 2.320 | 2.355 | 2.262 | 2.375 | | | | |
| MAX632x-XX | 24 (Note 2) | 2.364 | 2.400 | 2.436 | 2.340 | 2.460 | | | | |
| MAX632x-XX | 25 (Note 2) | 2.462 | 2.500 | 2.537 | 2.437 | 2.562 | | | | |
| MAX632x-XX | 26 | 2.591 | 2.630 | 2.669 | 2.564 | 2.696 | | | | |
| MAX632x-XX | 27 (Note 2) | 2.660 | 2.700 | 2.741 | 2.633 | 2.768 | | | | |
| MAX632x-XX | 28 (Note 2) | 2.758 | 2.800 | 2.842 | 2.730 | 2.870 | | | | |
| MAX632x-XX | 29 | 2.886 | 2.930 | 2.974 | 2.857 | 3.000 | | | | |
| MAX632x-XX | 30 (Note 2) | 2.955 | 3.000 | 3.045 | 2.925 | 3.075 | | | | |
| MAX632x-XX | 31 | 3.034 | 3.080 | 3.126 | 3.003 | 3.150 | | | | |
| MAX634x-XX | 33 (Note 2) | 3.250 | 3.300 | 3.350 | 3.217 | 3.383 | | | | |
| MAX634x-XX | 34 (Note 2) | 3.349 | 3.400 | 3.451 | 3.315 | 3.485 | | | | |
| MAX634x-XX | 35 (Note 2) | 3.447 | 3.500 | 3.552 | 3.412 | 3.587 | | | | |
| MAX634x-XX | 36 (Note 2) | 3.546 | 3.600 | 3.654 | 3.510 | 3.690 | | | | |
| MAX634x-XX | 37 (Note 2) | 3.644 | 3.700 | 3.755 | 3.607 | 3.792 | | | | |
| MAX634x-XX | 38 (Note 2) | 3.743 | 3.800 | 3.857 | 3.705 | 3.895 | | | | |
| MAX634x-XX | 39 (Note 2) | 3.841 | 3.900 | 3.958 | 3.802 | 3.997 | | | | |
| MAX634x-XX | 40 (Note 2) | 3.940 | 4.000 | 4.060 | 3.900 | 4.100 | | | | |
| MAX634x-XX | 41 (Note 2) | 4.038 | 4.100 | 4.161 | 3.997 | 4.202 | | | | |
| MAX634x-XX | 42 (Note 2) | 4.137 | 4.200 | 4.263 | 4.095 | 4.305 | | | | |
| MAX634x-XX | 43 (Note 2) | 4.235 | 4.300 | 4.364 | 4.192 | 4.407 | | | | |
| MAX634x-XX | 44 | 4.314 | 4.380 | 4.446 | 4.270 | 4.489 | | | | |
| MAX634x-XX | 45 (Note 2) | 4.432 | 4.500 | 4.567 | 4.387 | 4.612 | | | | |
| MAX634x-XX | 46 | 4.560 | 4.630 | 4.699 | 4.514 | 4.746 | | | | |

NOTES:

1. Factory-trimmed reset thresholds are available in 100 mV increments with $\pm 1.5\%$ tolerance at room temperature. 2. Consult factory for availability.



MAX632x/MAX634x

TYPICAL PERFORMANCE CURVES

MAX6326

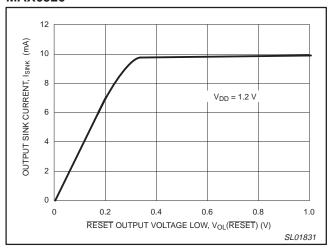


Figure 3. Output sink current vs. RESET output voltage low.

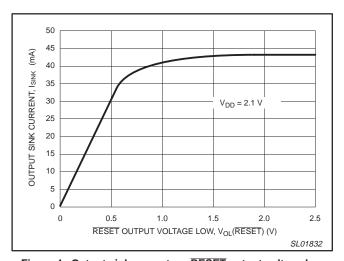


Figure 4. Output sink current vs. $\overline{\text{RESET}}$ output voltage low.

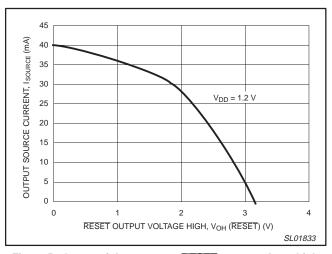


Figure 5. Output sink current vs. RESET output voltage high.

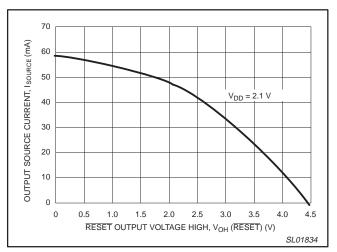


Figure 6. Output sink current vs. RESET output voltage high.



3-pin ultra-low power SC70/SOT microprocessor reset circuit

MAX632x/MAX634x

APPLICATION INFORMATION

Interfacing to µPs with Bidirectional Reset Pins

The MAX6328/MAX6348 RESET output is open drain and are easily interfaced with microprocessors which have bidirectional reset pins, such as the Motorola 68HC11. Directly connecting the MAX6328/MAX6348 RESET output to the μPs reset input and providing a pull-up resistor to V_{DD} allows either device to independently assert reset (Figure 7).

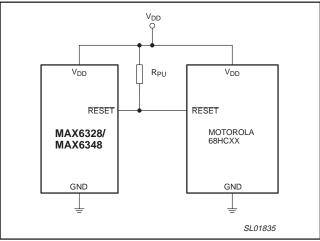


Figure 7. Interfacing to μ Ps with Bidirectional Reset Pins

Negative-going V_{DD} transients

The MAX6326-MAX6348 Series resets are relatively immune to short duration, negative-going V_{DD} transients or power glitches. This capability greatly reduces false resets with short-duration pulses.

Figure 8, Maximum Transient Duration versus Reset Comparator Overdrive, shows the maximum transient condition for which reset signal are not generated. The graph shows the maximum pulse width that a negative-going transient may have before it will generate a reset signal. Note: as the amplitude of the transient increases, the maximum allowable transient pulse width decreases.

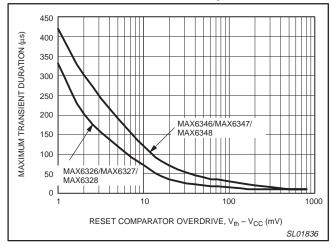
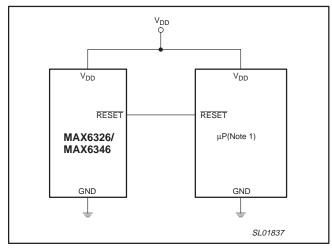


Figure 8. Maximum transient duration without causing a reset pulse versus reset comparator overdrive.

System configurations with various μPs

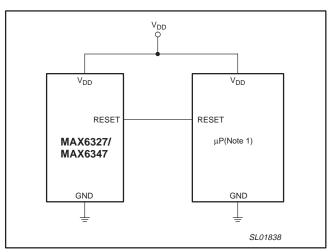
The MAX326-MAX6348 Series resets provide a system solution for various $\mu Ps.$ Figures 9 and 10, respectively, reference the Philips μPs which are compatible with the MAX6326/MAX6346 and MAX6327/MAX6347 system resets.



NOTE:

 Philips microprocessors with active-LOW resets: All 16-bit devices from XA-family (XA-Cxx, XA-Gxx, XA-Sxx, XA-Hxx), all LPC7xx devices (P87LPC760/761/762/767/768/769, P80C591/P87C591 (with on-chip CAN controller).

Figure 9. μP System Diagram using MAX6326/MAX6328 Push-Pull, Active-LOW Resets



NOTE:

 Philips microprocessors with active-HIGH resets: 8xC5x, 8xC3x, 8xC5xX2, 8xC3xX2, 8xC51Fx, 8xC51Rx+, 89C51Rx2, 89C66x, 8xC554, 8xC552, etc.

Figure 10. μP System Diagram using MAX6327/MAX6347 Push-Pull, Active-HIGH Resets



MAX632x/MAX634x

PACKING METHOD

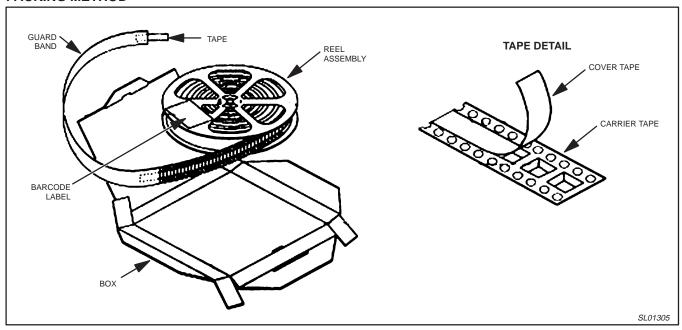
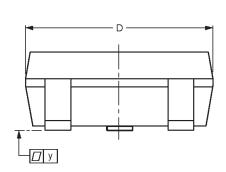
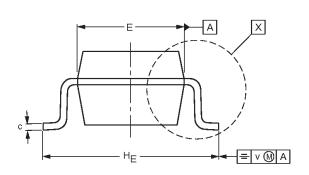


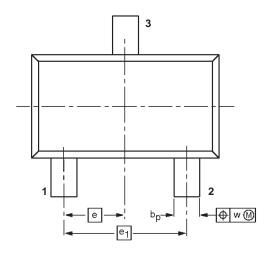
Figure 11. Tape and reel packing method.

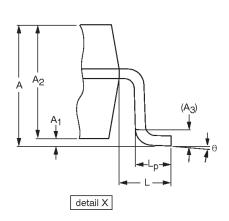
MAX632x/MAX634x

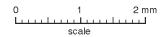
SOT23-3: plastic small outline package; 3 leads; body width 1.5 mm











DIMENSIONS (mm are the original dimensions)

| | , | | | | | | | | | | | | | | | |
|------|-----------|----------------|----------------|-------|--------------|--------------|------------------|------------------|------|----------------|--------------|------|--------------|--|-----|----------|
| UNIT | A max. | A ₁ | A ₂ | А3 | bp | c | D ⁽¹⁾ | E ⁽¹⁾ | е | e ₁ | HE | L | Lp | | у | θ |
| mm | 1.35 | 0.15 0.05 | 1.2 1.0 | 0.025 | 0.55 0.41 | 0.22 0.08 | 3.00 2.70 | 1.70 1.50 | 0.95 | 1.90 | 3.00 2.60 | 0.60 | 0.55 0.35 | | 0.1 | 8° 0° |

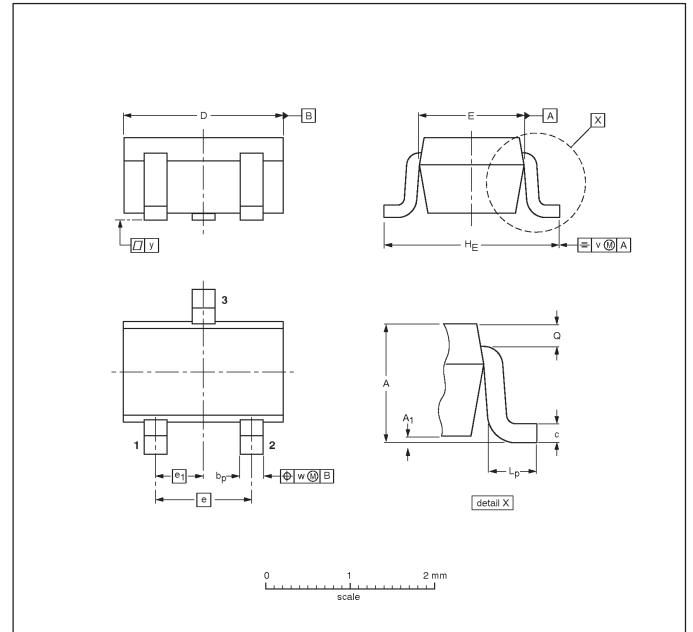
Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.



MAX632x/MAX634x

SC70-3: plastic small outline package; 3 leads; body width 1.15 mm



DIMENSIONS (mm are the original dimensions)

| UNIT | А | A ₁ max | bp | С | D | E | е | e ₁ | HE | Lp | Q | v | w |
|------|------------|-----------------------|-------------|---------------|------------|--------------|-----|----------------|------------|--------------|------------|-----|-----|
| mm | 1.0 0.8 | 0.1 | 0.4 0.25 | 0.225 0.10 | 2.1 1.9 | 1.35 1.15 | 1.3 | 0.65 | 2.2 2.0 | 0.45 0.15 | 0.4 0.1 | 0.2 | 0.2 |

| OUTLINE | | REFER | EUROPEAN | ISSUE DATE | | | |
|---------|-----|-------|----------|------------|------------|------------|--|
| VERSION | IEC | JEDEC | EIAJ | | PROJECTION | 1990E DATE | |
| | | | SC-70 | | | | |



3-pin ultra-low power SC70/SOT microprocessor reset circuit

MAX632x/MAX634x

REVISION HISTORY

| Rev | Date | Description | |
|-----|----------|---|--|
| _2 | 20030805 | Product data (9397 750 11124). ECN 853-2423 30165 dated 30 July 2003. Supersedes data of 30 Arpil 2003 (9397 750 10686). Modifications: | |
| | | ■ Table 1 on page 6, last row of table (suffix 46): V _{th} at T _{amb} = -40 to +85 °C: change from 4.3514 to 4.514 V. | |
| _1 | 20030430 | Product data (9397 750 10686). ECN 853-2423 29823 of 15 April 2003. | |

Data sheet status

| Level | Data sheet status ^[1] | Product status ^{[2] [3]} | Definitions |
|-------|----------------------------------|--------------------------------------|--|
| I | Objective data | Development | This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice. |
| II | Preliminary data | Qualification | This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product. |
| III | Product data | Production | This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN). |

^[1] Please consult the most recently issued data sheet before initiating or completing a design.

Definitions

Short-form specification — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

Application information — Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors make no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Disclaimers

Life support — These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips Semiconductors customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips Semiconductors for any damages resulting from such application.

Right to make changes — Philips Semiconductors reserves the right to make changes in the products—including circuits, standard cells, and/or software—described or contained herein in order to improve design and/or performance. When the product is in full production (status 'Production'), relevant changes will be communicated via a Customer Product/Process Change Notification (CPCN). Philips Semiconductors assumes no responsibility or liability for the use of any of these products, conveys no license or title under any patent, copyright, or mask work right to these products, and makes no representations or warranties that these products are free from patent, copyright, or mask work right infringement, unless otherwise specified.

Contact information

For additional information please visit http://www.semiconductors.philips.com.

For sales offices addresses send e-mail to:

sales.addresses@www.semiconductors.philips.com

Fax: +31 40 27 24825

Document order number:

© Koninklijke Philips Electronics N.V. 2003 All rights reserved. Printed in U.S.A.

Date of release: 08-03

9397 750 11124

Let's make things better.





^[2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL http://www.semiconductors.philips.com.

^[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.